

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Agarwal et al.

Art Unit: 2811

Application No. 09/590,795


CERTIFICATE OF MAILING

Filed: June 8, 2000

I hereby certify that this paper and the documents referred to as being attached or enclosed herewith are being deposited with the United States Postal Service on October 29, 2001 as First Class Mail in an envelope addressed to: Box Non-Fee Amendment, COMMISSIONER FOR PATENTS, WASHINGTON, D.C. 20231.

For: METHODS FOR FORMING AND INTEGRATED
CIRCUIT STRUCTURES CONTAINING
RUTHENIUM AND TUNGSTEN CONTAINING
LAYERS

Examiner: Cuong Q. Nguyen


Attorney for Applicant

Date: October 29, 2001

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RESPONSE TO RESTRICTION/ELECTION REQUIREMENT

In response to the Office action of September 28, 2001, please amend the subject application as follows:

In the claims:

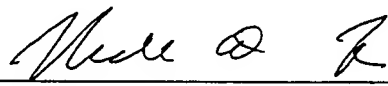
Please cancel claims 43-58, 64-65, and 71 without prejudice.

REMARKS

By this Amendment, Applicants elect the claims of Species I (claims 1-42, 59-63, and 66-70) for prosecution in the subject application and request cancellation of claims 43-58, 64-65, and 71 without prejudice. Applicants reserve the right to prosecute the non-elected claims in corresponding divisional applications.

Respectfully submitted,

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cc: Docketing
Client